



The Silicon Vertex Detector of Belle II

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Outline

- 1 Introduction to the Silicon Vertex Detector of the Belle II experiment
- 2 Operation and performance
- 3 Beam background and radiation effects
- 4 Conclusions

Belle II @ SuperKEKB

- Luminosity-frontier experiment exploring new physics beyond the Standard Model
- Asymmetric e^+e^- collisions at $\Upsilon(4S)$ mass (10.58 GeV)
- Target integrated luminosity: 50 ab^{-1}
- Target instantaneous luminosity: $6 \times 10^{35} \text{ cm}^{-2} \text{ s}^{-1}$
- Current record instantaneous luminosity: $3.1 \times 10^{34} \text{ cm}^{-2} \text{ s}^{-1}$



Essential for physics program

- Precise determination of decay vertices
- Low momentum tracking
- Good particle identification

The vertex detector

Requirements

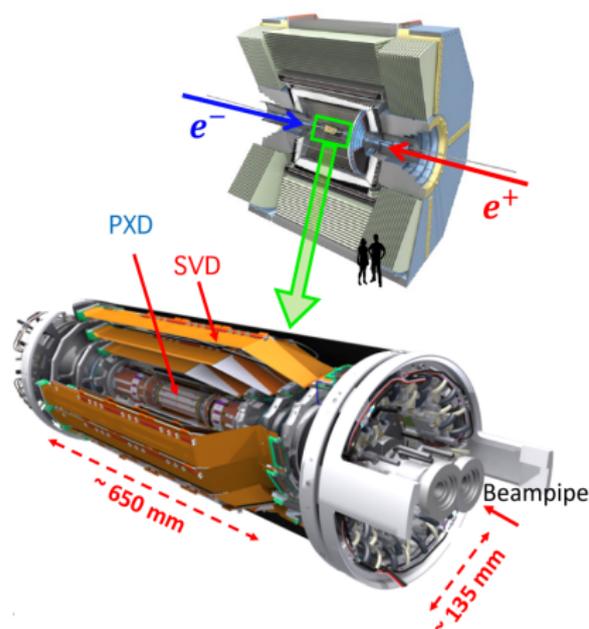
- Better vertex resolution w.r.t. Belle to compensate reduced Lorentz boost
 - improved point resolution
 - reduced inner radius
 - lower material
- Operate in high background environment
 - Hit rates: 20-3 MHz/cm²
@ R = 14-40 mm
- Radiation hard
 - 2-0.2 Mrad/yr @ R = 14-40 mm

Pixel Detector (PXD)

- DEPFET pixel sensors: layer-1-2
- Innermost layer 1.4 cm from interaction point

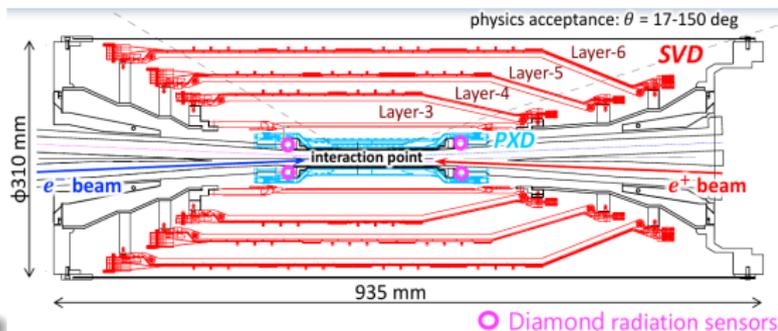
Silicon Vertex Detector (SVD)

- Double-sided Si strip sensors: layer-3-4-5-6



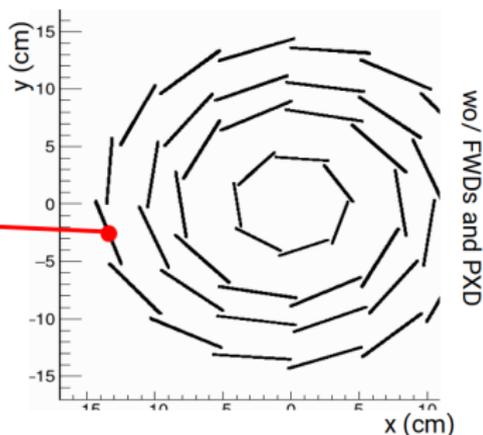
The Silicon Vertex Detector (SVD)

- Low material budget: $0.7\%X_0$ per layer
- Diamond sensors for radiation monitor and beam abort



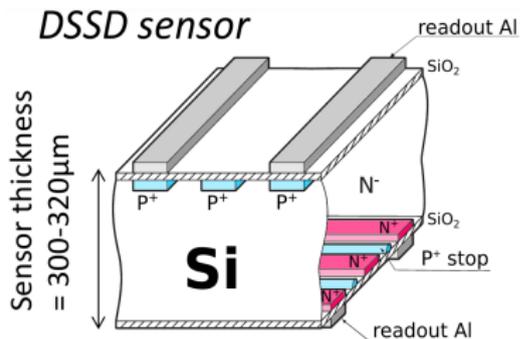
SVD Roles

- Extrapolate tracks to PXD
 - essential for reconstruction of decay vertices
 - PXD region of interest for data reduction
- Stand-alone tracking for low p_T tracks
- PID with dE/dx

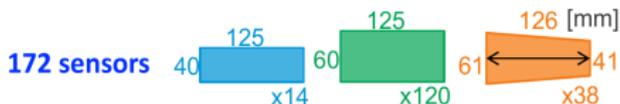
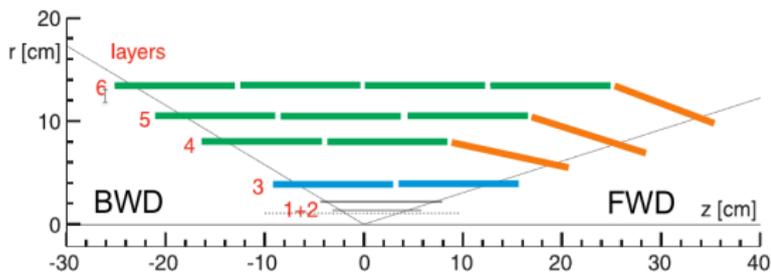
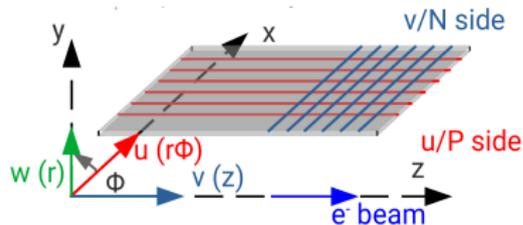


SVD: Double-side Silicon Strip Detector

Provide 2-D spatial information



AC-coupled strips on N-type substrate
Full depletion voltage: 20-60V
Operation voltage: 100V



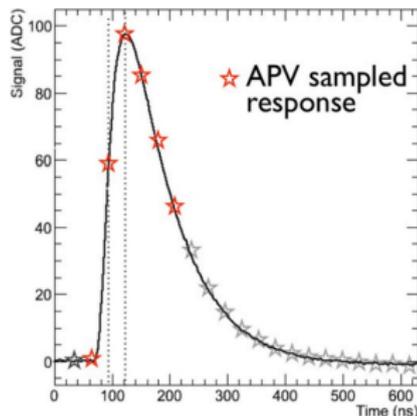
	Small	Large	Trapezoidal
# of p-strips*	768	768	768
p-strip pitch*	50 μm	75 μm	50-75 μm
# of n-strips*	768	512	512
n-strip pitch*	160 μm	240 μm	240 μm
thickness	320 μm	320 μm	300 μm
manufacturer	HPK		Micron

*readout strips – one floating strip on both sides

Total: 172 sensors, 1.2 m² sensor area and 224k readout strips

Front-end ASIC: APV25

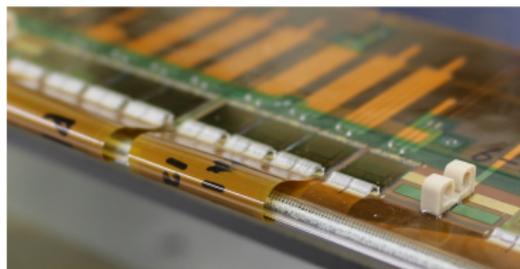
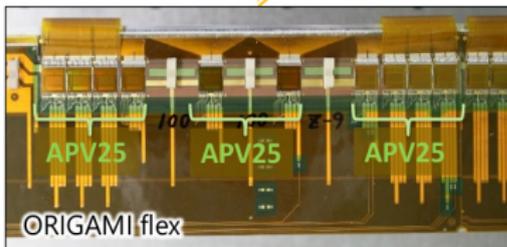
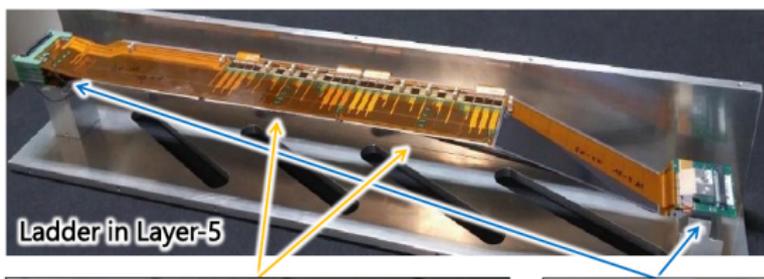
- Originally developed for CMS silicon tracker
- **Fast:** 50 ns shaping times
- **Radiation hard:** >100 Mrad
- **Power consumption:** 0.4 W/chip (700 W in total)
- 128 channel inputs per chip
- Operated in a multi-peak mode @ ~ 32 MHz
 - Bunch-crossing frequency $\sim 8 \cdot 32$ MHz, clock not synchronous with them as in CMS
 - 6 subsequent samples recorded
 - 3/6-mixed acquisition mode also prepared to reduce the dead time, data size and occupancy at higher luminosity



Origami chip on sensor concept

Readout chips directly on each middle sensor

- shorter signal propagation length (smaller capacitance and noise)
- Thinned to 100 μm to reduce material budget

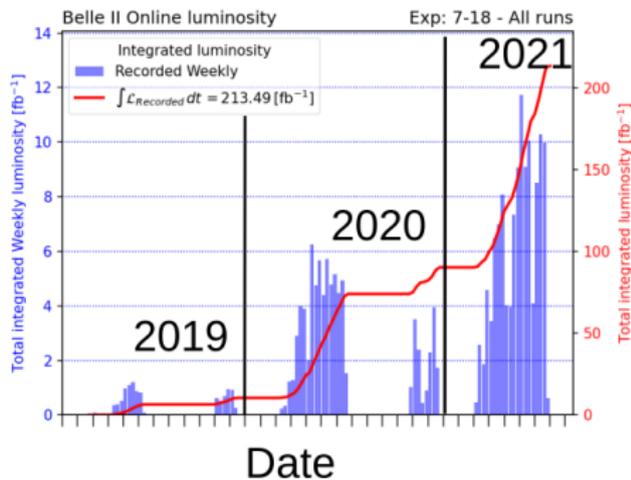


- Wrapped flex to read both sides from the same side
- Cool only one side with bi-phase -20°CO_2

Operation and performance

Operational experience

- SVD installed in 2018, operated since 2019
- Reliable and smooth operation without major problems
 - ▶ Total fraction of masked strips $\sim 1\%$
 - ▶ One APV25 chip disabled in spring 2019 (out of 1748), fixed by cable reconnection in summer 2019
- Excellent detector performance
 - ▶ Average sensor hit efficiency $> 99\%$ and stable with time



Signal charge and signal to noise ratio

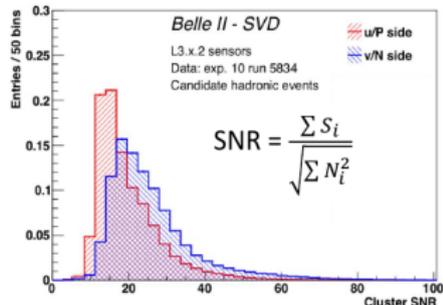
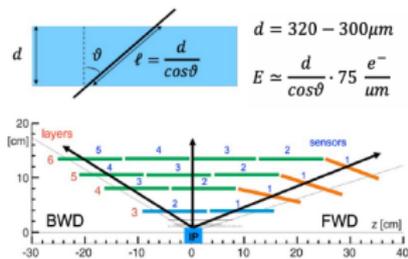
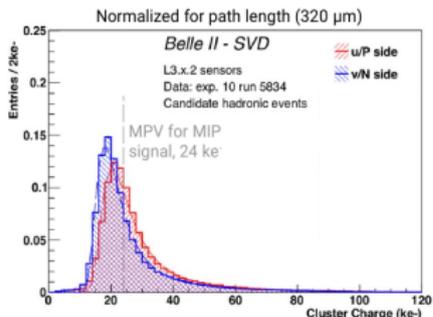
Signal charge normalised for the track path length in silicon **similar in all sensors and matches expectations**

u/P side: charge in agreement with expectation from MIP taking into account $\sim 15\%$ uncertainty in APV25 gain calibration

v/N side: 10%-30% signal loss due to large pitch and presence of floating strip

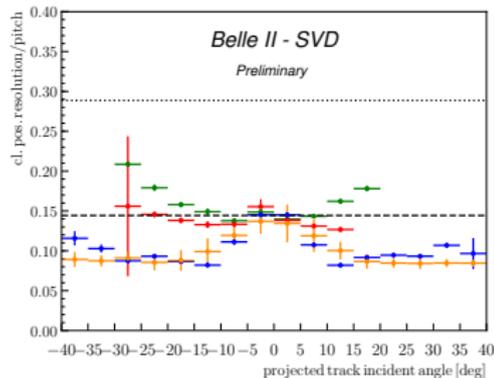
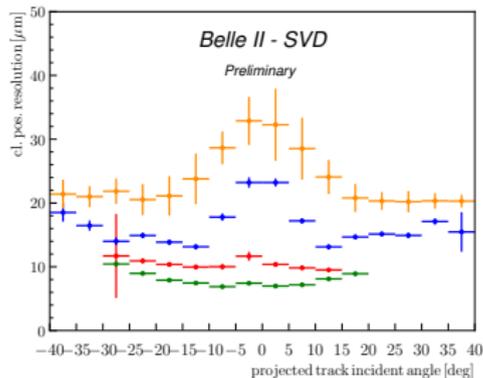
Very good SNR in all 172 sensors (most probable value: 13-30)

u/P side: larger noise due to longer strip length (larger inter-strip capacitance)



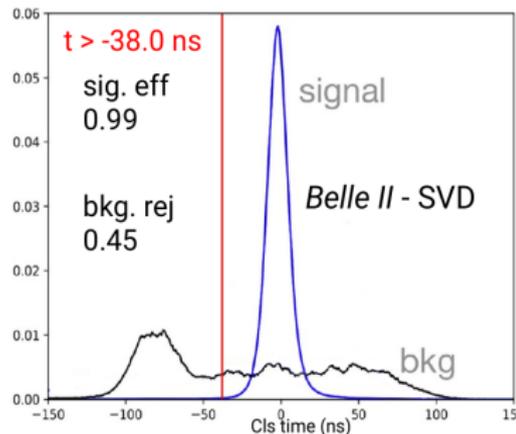
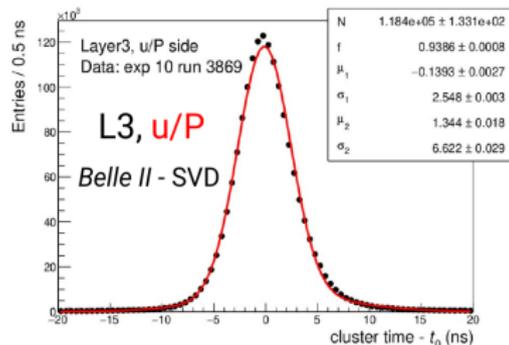
Cluster position resolution

- Preliminary cluster position resolution measured on data
- Estimated from the residuals of the cluster position with respect to the track (unbiased) using $e^+e^- \rightarrow \mu^+\mu^-$ events
- Effect of the track extrapolation error subtracted
- Excellent position resolution in agreement with the expectations from the pitch
- Still room for improvement for the u/P side (work ongoing)



Hit time resolution

- Excellent hit time resolution wrt event time provided by CDC (~ 2.9 ns u/P, ~ 2.4 ns v/N)
- Possible to efficiently reject off-time background hits
 - Will be used for higher luminosity and background levels

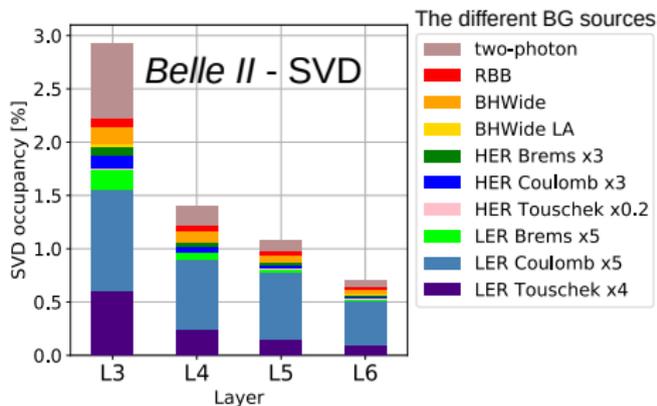


Beam background and radiation effects

Beam background

Beam background increases SVD hit occupancy which degrades tracking performance

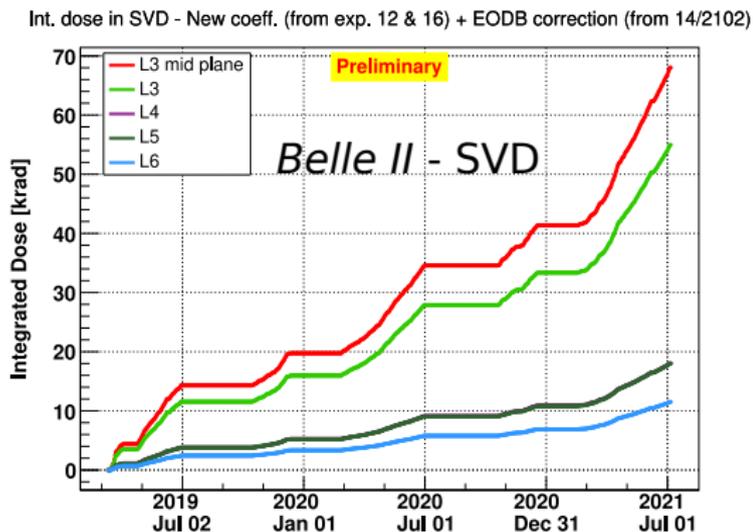
- Present occupancy limit in layer-3: $\sim 3\%$
- Using hit time information to reject background can approximately be doubled
- With current luminosity average hit occupancy in layer-3 is **well under control** ($< 0.5\%$)
- Projection of hit occupancy at $\mathcal{L} = 8 \times 10^{35} \text{ cm}^{-2} \text{ s}^{-1}$ is about 3% in layer-3
 - estimated scaling MC with data/MC ratio
 - correspond to dose of $\sim 0.2 \text{ Mrad/smy}$ and 1-MeV neutron fluence of $\sim 5 \times 10^{11} \text{ neq/cm}^2/\text{smy}$ ($\text{smy} = 10^7 \text{ s}$)
- Long term BG extrapolation affected by large uncertainties related to collimation and injection BG still not included



Integrated dose

SVD dose estimated by dose on diamond sensors: 70 krad in layer-3 mid plane (the most exposed to radiation)

- Dose estimate based on correlation between SVD occupancy and diamonds dose
- Several assumptions and large uncertainty ($\sim 50\%$)



1-MeV equivalent neutron fluence: $\sim 1.6 \times 10^{11}$ neq/cm² in first 2.5 years (assuming dose/neq fluence ratio = 2.3×10^9 neq/cm²/krad from MC)

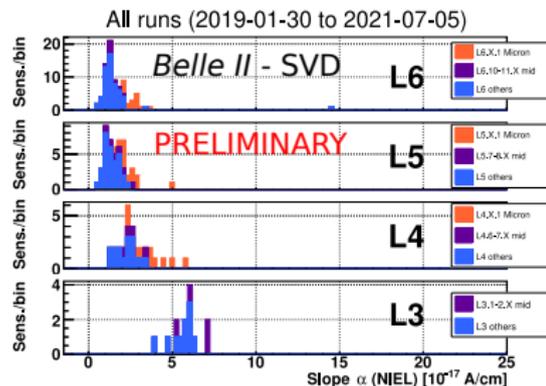
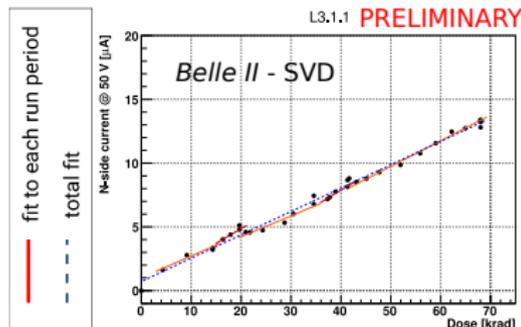
Radiation effect on leakage current

Good linear correlation between leakage current and estimated dose

- Slope: $2\text{--}5 \mu\text{A}/\text{cm}^2/\text{Mrad}$ with large variations due to temperature effects and dose spread among sensors in layer (average dose in layer used in estimate)
- Same order of magnitude as BaBar measurement ($1 \mu\text{A}/\text{cm}^2/\text{Mrad}$ @ 20°C) [NIMA 729, 615-701, 2013]

Even after 10 Mrad irradiation, leakage current will not significantly affect strip noise

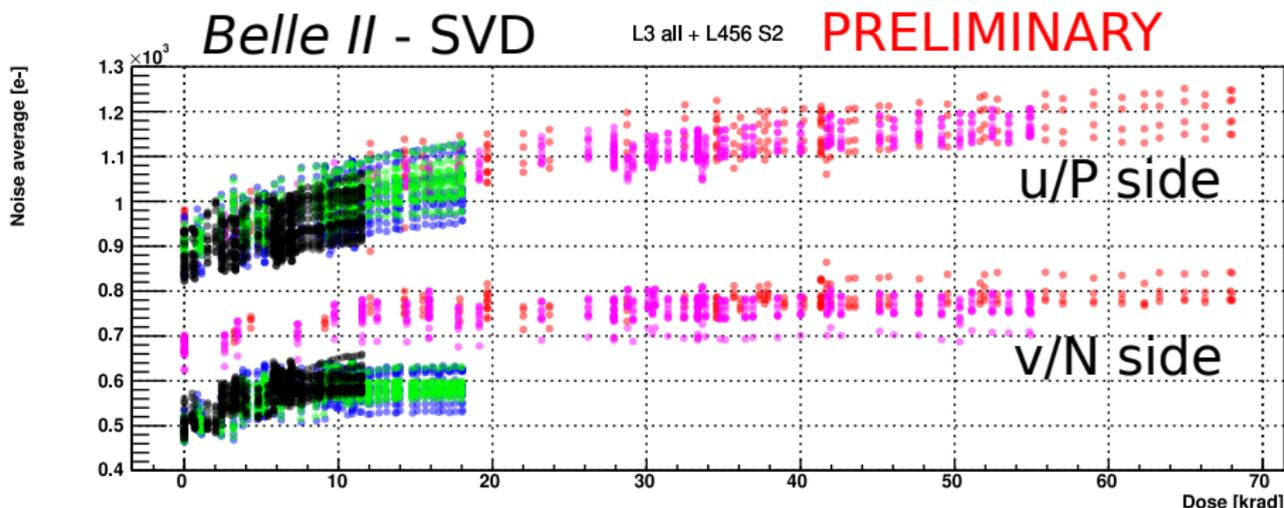
- Noise dominated by sensor capacitance because of short shaping time (50ns) in APV25



Radiation effect on strip noise

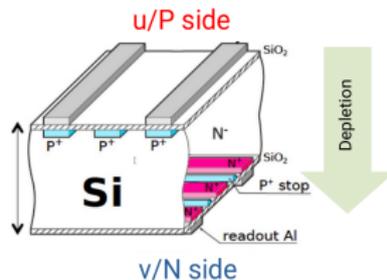
Noise increase of 20-25% in layer-3

- Not affecting performance
- Likely due to radiation effects on sensor surface
 - Non-linear increase due to fixed oxide charges that increase inter-strip capacitance,
 - expected to saturate
- Saturation seen on v/N side and starting to be seen on u/P

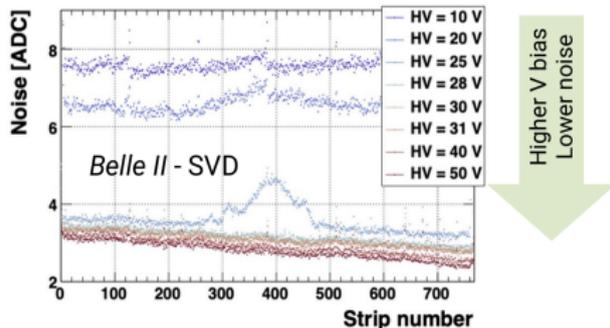


Radiation effect on depletion voltage

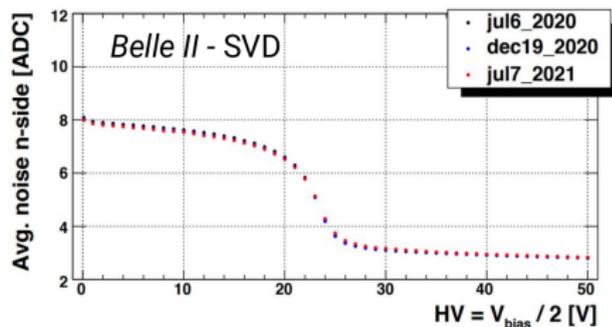
- Minimum of v/N side strip noise at full depletion
 - ▶ v/N side insulated only when the n-type bulk is fully depleted
 - ▶ Over-depletion bias still slightly decrease noise (reduce electron accumulation layer on n-side surface)
- No change in full depletion voltage observed with time: consistent with low integrated neutron fluence ($\sim 1.6 \times 10^{11} \text{ neq/cm}^2$)



L3.5.1 v/N Side - Strip Noise



L3.5.1 N Side - Noise



Conclusions

- SVD has been taking data in Belle II since March 2019 smoothly and reliably
- Excellent performance in agreement with expectations
 - Still some room for improvement in cluster position resolution
- Seen first effects of radiation damage at the expected level but not affecting performance
- Ready to cope with increased beam background
 - Reject off-time background
 - 3/6 mixed acquisition mode to reduce dead time, data size and occupancy